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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/986,577	11/09/2001	Takashi Hiroi	501.40830VX1	5835	
20457	7590 09/03/2004	EXAMINER			
	LI, TERRY, STOUT &	STREGE, JOHN B			
SUITE 1800	SEVENTEENTH STR	ART UNIT	PAPER NUMBER		
ARLINGTON	I, VA 22209-9889	2625	9.0		
			DATE MAILED: 09/03/2004	\mathcal{U}	

Please find below and/or attached an Office communication concerning this application or proceeding.

			Application No.		Applicant(s)				
Office Action Summary		09/986,577		HIROI ET AL.					
		Examiner		Art Unit	T				
	-		John B Strege		2625				
	The MAILING DATE of this communi	cation appe		et with the co		ddress			
Period fo									
THE - External after - If the - If NC - Failu	ORTENED STATUTORY PERIOD FOR MAILING DATE OF THIS COMMUNION IN THE PROPERTY OF THIS COMMUNION IN THE PROPERTY OF THE PROPERTY	CATION. of 37 CFR 1.136 unication. o) days, a reply vitutory period will will, by statute, o	6(a). In no event, however, ma within the statutory minimum o Il apply and will expire SIX (6) cause the application to becom	ay a reply be time of thirty (30) days MONTHS from to	ely filed will be considered time he mailing date of this of				
Status									
1) 又	Responsive to communication(s) filed	d on <i>09 No</i>	vember 2001.						
·	·		action is non-final.						
′	Since this application is in condition f	<i>'</i> —		natters, pros	secution as to the	e merits is			
,	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.								
Dispositi	on of Claims								
_		annlication							
•	Claim(s) 16-27 is/are pending in the application.								
	4a) Of the above claim(s) is/are withdrawn from consideration.								
· _	5) Claim(s) is/are allowed. 6) Claim(s) <u>16-27</u> is/are rejected.								
	Claim(s) <u>16-27</u> is/are objected to.								
·	Claim(s) are subject to restrict	ion and/or	election requirement.						
	.,		·						
	on Papers								
9) The specification is objected to by the Examiner.									
10)	10)⊠ The drawing(s) filed on <u>03 May 2002</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.								
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
441	Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.								
11)	The oath or declaration is objected to	by the Exa	iminer. Note the attac	nea Onice /	Action of form P	10-152.			
Priority u	inder 35 U.S.C. § 119								
	Acknowledgment is made of a claim for All b) Some * c) None of: 1. Certified copies of the priority of Certified copies of the priority of Ceptified copies of the priority of None of the certified copies of the certified copies of the Internation	documents documents of the priorit	have been received. have been received i y documents have be	in Applicatio	n No. <u>09/986,29</u>				
* S	ee the attached detailed Office action	for a list o	f the certified copies i	not received	d .				
2) Notice	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PT		Paper	ew Summary (I No(s)/Mail Dat	e	0.450)			
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 5) Notice of Informal Patent Application (PTO-152) 6) Other:						J-152)			
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DETAILED ACTION

Specification

1. The substitute specification has been received and entered. Claims 1-15 have been cancelled and 16-27 are pending. The disclosure is objected to because of the following informalities: in the preliminary amendment of the specification (paper #2A) the serial number of the parent application (09/986,299) should be listed.

Appropriate correction is required.

Double Patenting

2. The nonstatutory double patenting rejection is based on a judicially created doctrine grounded in public policy (a policy reflected in the statute) so as to prevent the unjustified or improper timewise extension of the "right to exclude" granted by a patent and to prevent possible harassment by multiple assignees. See *In re Goodman*, 11 F.3d 1046, 29 USPQ2d 2010 (Fed. Cir. 1993); *In re Longi*, 759 F.2d 887, 225 USPQ 645 (Fed. Cir. 1985); *In re Van Ornum*, 686 F.2d 937, 214 USPQ 761 (CCPA 1982); *In re Vogel*, 422 F.2d 438, 164 USPQ 619 (CCPA 1970);and, *In re Thorington*, 418 F.2d 528, 163 USPQ 644 (CCPA 1969).

A timely filed terminal disclaimer in compliance with 37 CFR 1.321(c) may be used to overcome an actual or provisional rejection based on a nonstatutory double patenting ground provided the conflicting application or patent is shown to be commonly owned with this application. See 37 CFR 1.130(b).

Effective January 1, 1994, a registered attorney or agent of record may sign a terminal disclaimer. A terminal disclaimer signed by the assignee must fully comply with 37 CFR 3.73(b).

3. Claims 16-27 are provisionally rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 16-27 of copending Application No. 09986299. Claims 16-27 are directed to an apparatus for pattern inspection and claims 1-15 of the copending application are

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directed to a method of pattern inspection with similar limitations. Method and apparatus claims are not patentably distinct.

Claim 17 of the instant application discloses, "A pattern inspection apparatus comprising: image detecting means for attaining a digital image of an object substrate through microscopic observation thereof (claim 1 of copending application lines 1-3); defect detecting means for detecting defects in examination of the digital image attained by the image detecting means while masking a pre-registered region or a pattern meeting a pre-registered pattern (claim 1 lines 4-6); and output means for outputting data regarding the defects detected by the defect detecting means (claim 1 of copending application lines 7-8)."

Furthermore, although the conflicting claims are not identical, they are not patentably distinct from each other because the limitations are only worded differently however have similar subject matter. The additional limitations that exist in some of the claims such as a memory part for storing coordinated data of a non-inspection region to be masked (claim 16) are well known in the art as disclosed by Murase USPN 5,321,767. Murase discloses determining the position of examination region or mask in step 17 of figure 2.

This is a <u>provisional</u> obviousness-type double patenting rejection because the conflicting claims have not in fact been patented.

Claim Objections

4. Claims 16-27 are objected to because of the following informalities: Each of the claims contains examples of single words separated by spaces such as

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"digi tal" in line 2 of claim 16. Appropriate correction for all of these occurrences in the claims is required.

Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. Claims 16-27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Inokuchi USPN 6,259,960 in view of Murase USPN 5,321,767.

Regarding claim 17 Inokuchi discloses a part-inspecting system for detecting the presence of a defect on an inspected part, such as a silicon wafer, storing information about defects, and using the stored information for later operations to detect defects on parts (col. 1 lines 4-14). When a part to be inspected, i.e., a wafer on which a pattern is formed, is placed in position for inspection the optical defect-inspecting apparatus 02 (figure 72) automatically detects the size and position of any defect (col. 2 lines 16-22). This forms the preliminary inspection step and an optical microscope can be used (col. 3 lines 35-36 and lines 43-46). The preliminary inspection information files can be displayed as shown in figures 73A and 73 B (col. 2 lines 41-56) where 73A shows the contour of a wafer under inspection, as well as the positions of defects on the inspected part and 73B shows the defect position, sizes, and other

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information. The operator watches the images of figures 73A and 73B and manually specifies the defect that he wants to review closer using a scanning electron microscope (col.3 lines 20-30).

Inokuchi does not explicitly disclose detecting defects of the attained digital image while masking a pre-registered region or pattern.

Murase discloses a method forming a mask in an image processing operation for indicating a non-examination region that is to be excluded from the inspection of the appearance of articles (col. 1 lines 8-12, and col. 3 lines 57-60). As seen in figure 6, one possible article of inspection is an integrated circuit 26 (col. 5 lines 46-47). Murase recites that there is a problem in the prior art with inspecting articles when non-critical spots on the article such as printed letters show up as defects, and it is difficult to discriminate between defective parts and the letters (col. 2 line 61 – col. 3 line 10). Murase further recites that such a problem would be overcome by forming a masking region that would conceal the printed letters so as to neglect the data carried by the pixels inside such a mask (col. 3 lines 10-14).

Inokuchi and Murase are analogous art because they are from the same field of endeavor of inspection of semiconductor materials.

At the time of the invention it would have been obvious to one of ordinary skill in the art to combine Inokuchi and Murase to obtain a microscopic inspection device that takes an image of a semiconductor and masks out defects that are non-critical. The motivation for doing so is that it would speed up the process of inspection by not having to take into account uncritical areas. Thus, it would have

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been obvious to one of ordinary skill in the art to combine Inokuchi and Murase to obtain the invention as specified in claim 17.

Claim 16 is similar to claim 17, although claim 16 has the additional limitation of a memory part for storing coordinate data of the masked region.

Claim 16 is also different in that it has a broader image detecting part since it does not specify microscopic observation. Therefore the microscopic observation mentioned above by Inokuchi meets this limitation. Furthermore, Murase discloses determining the position of the mask in step 17 of figure 2. The rest of the limitations have already been addressed in the rejection of claim 16.

Regarding claim 18, Murase discloses that taking an image of the object to obtain image data and processing said image data by an image processing apparatus where a mask indicating a non-examination region which is to be set is decided from the image (col. 3 lines 52-60). As discussed Inokuchi discloses the microscopic observation.

Regarding claim 19, as seen in figure 73a of Inokuchi, data regarding the entire wafer is output in the preliminary step. As discussed Inokuchi discloses that the operator watches the images of figures 73a and 73b and lists the defects that might adversely affect the quality of the inspected part and specifies the defects that he or she wants to review (col. 3 lines 20-25), thus all defects critical and non-critical are seen by the operator. Combining this with Murase, it would be obvious to output the defects found on the entire wafer including the masked regions so that an operator reviewing the wafer would know which defects have

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been masked as non-critical and which defects are critical, thus avoiding confusion in later reviews of the wafer.

Claim 26 is similar to claims 16 with the additional limitations of extracting defects located in predefined regions, classifying the extracted defects through examination, and outputting the class data. Inokuchi discloses that the defect information (figure 22a) about the wafer is searched for defect points having sizes lying in a specified range. Among them, some points Wa and Wb (figure 22b) spaced from each other are extracted (col. 37 lines 43-51). Inokuchi further discloses classifying the defects (at least col. 46 lines 48-56). Furthermore the classified results can be displayed (col. 75 lines 40-44). The rest of the limitations have already been addressed in the previous claim 16.

Claim 20 is similar to claim 26, only broader; therefore the same arguments used for claim 26 apply equally to the rejection of claim 20.

Claim 21 is similar to claim 18, thus the same arguments used for the rejection of claim 18 apply equally to the rejection of claim 21.

Regarding claim 22, as discussed Inokuchi discloses extracting defects and a reviewer checks the defects based on a preliminary image with position data of the defects as seen in figures 73a, and 73b.

Claim 23 is similar to claim 26 only broader; therefore the same arguments used for claim 26 apply equally to the rejection of claim 23.

Claim 24 is similar to claim 18, thus the same argument used for claim 18 applies equally to claim 24.

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Regarding claim 25, figure 73b of Inokuchi discloses the position and size of the defects as seen on a display viewed by the operator.

Regarding claim 27, as discussed Inokuchi discloses displaying the classified defects.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Hennessey et al. USPN 6,246,787 System and method for knowledgebase generation and management.

Levy et al. USPN 4,247,203 Automatic photomask inspection system and apparatus. Especially the definition of mask parameters (col. 15 lines 39-61).

Contact Information

Any inquiry concerning this communication or earlier communications from the examiner should be directed to John B Strege whose telephone number is (703) 305-8679. The examiner can normally be reached on Monday-Friday between the hours of 8-5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Bhavesh Mehta can be reached on (703) 308-5246. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

JS